

Orderable: N/A	Designed for: Public Release	Mod. Date: 5/16/2018
TID #: PMP15039	Project Title: Two-Stage Power Supply for Field Transmitters Ref	
Number: PMP15039	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: PMP15039.SchDoc	Size: B
Engineer: Katelyn Wiggenhorn	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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PCB Number: PMP15039  
PCB Rev: E1


PCB  
LOGO  
Logo1

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Drawn By:	File: PMP15039_Hardware.SchDoc	Size: B	
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